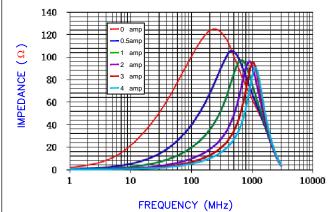
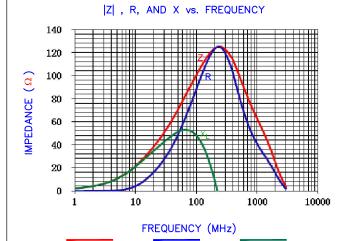
HI0805P121R-10

PHYSICAL DIMENSIONS:

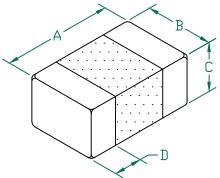
A 2.00 [.079] ± 0.20 [.008] B 1.25 [.049] ± 0.20 [.008] C 0.90 [.035] ± 0.20 [.008]

Z vs FREQUENCY IMPEDANCE UNDER DC BIAS





AGILENT E4991A RF Impedance/Material Analyzer AGILENT 16194A.

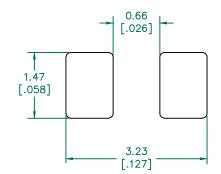


ELEC.	ELECTRICAL CHARACTERISTICS:						
	Z @ 100MHz $\left(\begin{array}{c}\Omega\end{array}\right)$		Rated Current				
Nominal	120						
Minimum	linimum 90						
Maximum	150	0.02	4000 mA				

NOTES: UNLESS OTHERWISE SPECIFIED

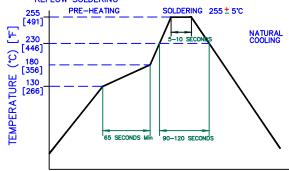
- 1. TAPED AND REELED per CURRENT EIA SPECIFICATIONS 7" REELS, 4000 PCS/REEL, PAPER TAPER.
- 2. COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
- 3. TERMINATION FINISH IS 100% TIN.
- 4. OPERATEING TEMP. RANGE: -55°C~+125°C (INCLUDING SELF-HEATING)

LAND PATTERNS FOR REFLOW SOLDERING



(For wave soldering, add 0.763 [.030] to this dimension.)

RECOMMENDED SOLDERING CONDITIONS REFLOW SOLDERING



		DIMENSIONS ARE IN mm [INCHES].			This print is the property of Lai					
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					copies shall be made without th written consent of Laird Tech. A		Land			
۱۷					rights to design or invention are					
)					reserved.					
1					PROJECT/PART NUMBER:	REV	PART TO	PE:	DRAWN BY:	
ŀ					HI0805P121R-10	В	B CO-FIRE		QU	
	В	CHANGE OPERATEING TEMP	10/13/17	QIU	DATE: 40 /05 /47	SCALE:	TC	SHEET:		
ı	Α	ORIGINAL DRAFT	10/25/13	QU	10/25/13	TOOL #	TS			
	REV	DESCRIPTION	DATE	INT		IOOL #		1	of 1	

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<u>Laird Performance Materials</u>:

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